

NCE P-Channel Enhancement Mode Power MOSFET

Description

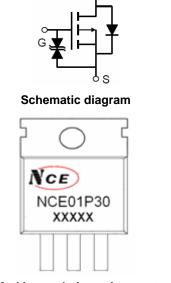
The NCE01P30 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

- V_{DS} =-100V,I_D =-30A
 R_{DS(ON)} <58mΩ @ V_{GS}=-10V (Typ:50mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

• Portable equipment and battery powered systems



D

Marking and pin assignment



100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

V	0	U			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P30	NCE01P30	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-30	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	-21	А
Pulsed Drain Current	I _{DM}	-120	А
Single pulse avalanche energy (Note 5)	E _{AS}	360	mJ
Maximum Power Dissipation	PD	120	W
Derating factor		0.8	W/℃
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	1.25	°C/W
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Electrical Characteristics (T_c=25[°]C unless otherwise noted)

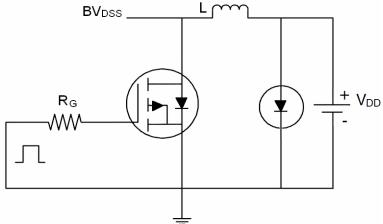
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-1.9	-2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-15A	-	50	58	mΩ
Forward Transconductance	g fs	V _{DS} =-50V,I _D =-10A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	N/ 50)()/ 0)/	-	8049	-	PF
Output Capacitance	C _{oss}	V_{DS} =-50V, V_{GS} =0V,	-	184.5	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	179	-	PF
Switching Characteristics (Note 4)						•
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-15A	-	80	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =9.1Ω	-	45	-	nS
Turn-Off Fall Time	t _f		-	65	-	nS
Total Gate Charge	Qg		-	120	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-50V,I _D =-15A,	-	22	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	26.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V
Diode Forward Current (Note 2)	I _S	-	-	-	-30	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-15A	-	90	-	nS
Reverse Recovery Charge	Qrr	(Niste 2)		150	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negli	gible (turi	n-on is do	minated b	y LS+LD)

Notes:

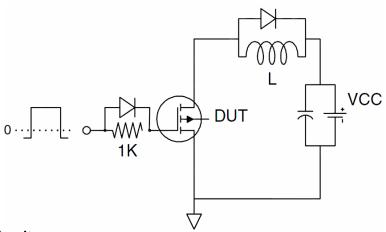
- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ\!\mathrm{C}$,V_DD=-50V,V_G=-10V,L=0.5mH,Rg=25 Ω



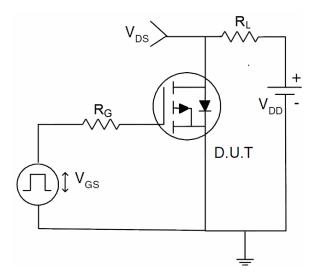
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

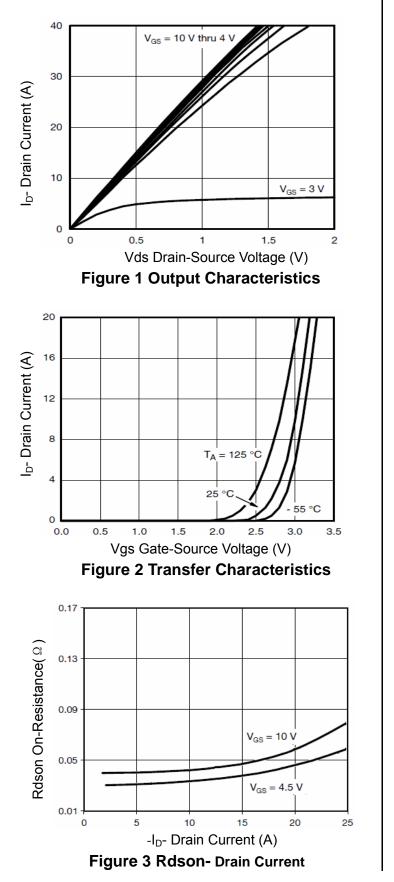


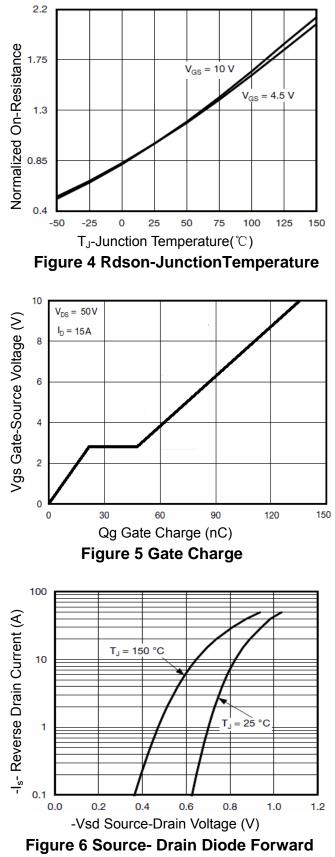
3) Switch Time Test Circuit





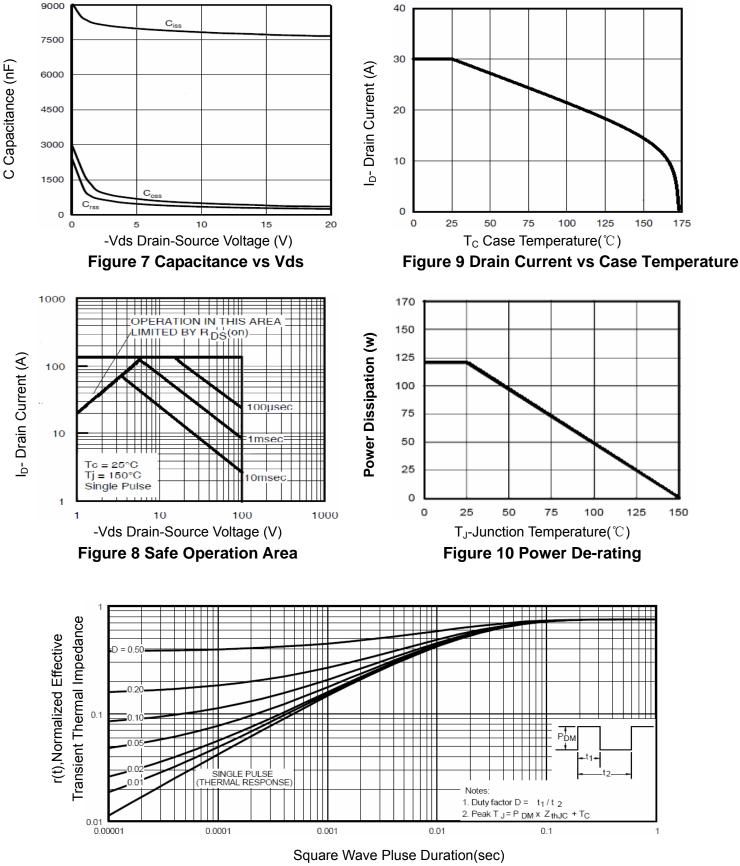
Typical Electrical and Thermal Characteristics (Curves)







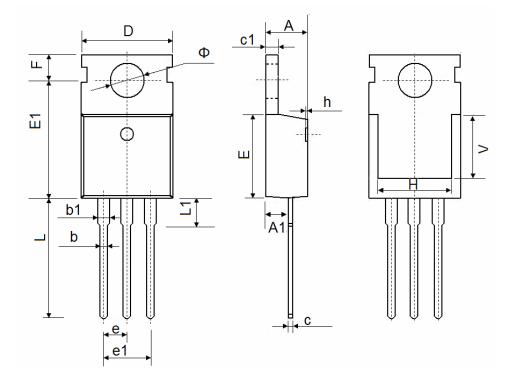
http://www.ncepower.com







TO-220-3L Package Information



Cumhal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.54	0 TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295	REF.	
Φ	3.400	3.800	0.134	0.150	



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